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# The Mechanism of Photohydrosilylation on Silicon and Porous <sup>2</sup> Silicon Surfaces

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ABSTRACT: Visible or UV light activates H-terminated Si surfaces because of the 5 presence of a photogenerated hole in a Si-Si back-bond. Enhancing the lifetime of this 6 hole at the surface increases reactivity. On the basis of photodynamics and electron transfer 7 8 theory, the prevalence of two mechanisms of photoactivation (internal photoemission versus interband photoexcitation followed by electron transfer) are explored. To act as an 9 effective trap, an acceptor state for the excited electron must either be populated directly by 10 photoexcitation or the state must lie in a band gap (or both). It is predicted that oxidants 11 with a properly positioned acceptor level will enhance the reactivity of porous silicon or 12

silicon nanocrystals in a size selective manner. 13



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15 The ability to tune the solubility, wettability, and dissolution 16 behavior of nanocrystalline silicon (nc-Si) by variations in 17 surface termination makes porous silicon (por-Si) an ideal 18 vehicle for drug delivery.<sup>1-3</sup> Silicon nanoparticles exhibit 19 improved solubility in polar solvents when longer alkyl chains 20 are attached to them.<sup>4</sup> Carboxylic acid-terminated Si nano-21 particles do not exhibit cytotoxicity, whereas amine-terminated 22 Si nanoparticles do.<sup>5</sup> H-terminated surface are easily 23 resorbed,<sup>6,7</sup> whereas derivatization can inhibit the corrosion 24 of por-Si surfaces.<sup>8</sup> Decelerated dissolution can slow the release 25 of a steroid that has been loaded into the pores.<sup>9</sup>

Sailor and co-workers followed up the first thermal 26 <sup>27</sup> modifications of Si surfaces with work on the photoreactivity <sup>28</sup> of por-Si surfaces.<sup>10–12</sup> Direct patterning of crystalline Si (c-Si) 29 surfaces with adsorbed alkoxide layers by photoactivation soon 30 followed.<sup>13,14</sup> Chidsey<sup>15-17</sup> and Buriak<sup>14,18-20</sup> extensively 31 studied the photo-initiated hydrosilylation of Si and por-Si 32 surfaces.

Stewart and Buriak implicated excitons in the reaction 33 34 mechanism.<sup>18</sup> Sun et al.<sup>21</sup> extended this mechanism by invoking 35 a surface localized valence band hole coupled to radical 36 formation and propagation. Reaction proceeds by nucleophilic 37 attack of the Si surface at the site excited by the presence of the 38 hole. In a chain reaction, this is followed by H abstraction from 39 a neighboring site that allows for radical propagation.

Experiments consistent with the involvement of photo-40 41 generated holes to enhance reactivity of Si-H bonds on both 42 extended surfaces and nanoparticles have been performed by a 43 number of groups.<sup>22-25</sup> However, controversy still exists 44 regarding the details of the mechanism and how the reactivity 45 of the holes can be enhanced. Huck and Buriak<sup>20</sup> have found 46 that for white light illumination the addition of oxidants 47 possessing an acceptor level can enhance photoreactivity if the

level resides below the conduction band minimum. They 48 ascribe this to the oxidant's ability to overcome the exciton 49 binding energy. 50

Hamers and co-workers have shown that UV excitation can 51 be quite effective at grafting of terminal alkenes not only to 52 Si,<sup>26,27</sup> but also to diamond and other carbon surfaces.<sup>28</sup> They 53 illuminated Ar-sparged neat alkenes in contact with a surface 54 with 254 nm light at  $\sim 10$  mW cm<sup>-2</sup>. They suggested<sup>26</sup> that ss internal photoemission is important during the grafting. 56 Internal photoemission is electron transfer from the solid 57 substrate to an acceptor species in solution by direct 58 photoexcitation. They demonstrated that this mechanism 59 works particularly well with diamond surfaces and molecules 60 that possess an acceptor level that resides below the vacuum 61 level of the solid. Huck and Buriak<sup>29</sup> found that aromatic 62 groups are particularly effective at enhancing reactivity with H- 63 terminated Si surface under 254 nm irradiation. 64

In this report, I discuss the photodynamics responsible for 65 photochemistry at Si surfacesand then develop a quantitative 66 model to fit the data of Huck and Buriak, which takes into 67 consideration both internal photoemission and electron transfer 68 in enhancing the rate of reaction. This work puts a firm 69 theoretical foundation under the suggestion in ref 26 that the 70 rate of reaction is enhanced because removal of the electron 71 from the substrate increases the lifetime of the hole that 72 initiates reactivity. 73

## RESULTS AND DISCUSSION

The initiator of UV- and visible-irradiation-induced photo-75 chemistry by nucleophilic attack at H/Si surfaces is a 76 thermalized hole at the top of the valence band not Si-H 77



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78 bond cleavage. By conservation of energy, the Si−H bond could 79 in principle be photodissociated with a photon of wavelength  $\lambda$ 80 ≤ 410 nm. There are, however, no electronic transitions at this 81 wavelength. In fact, direct photodissociation of the Si−H bond 82 only begins to occur with a measurable probability at a 83 wavelength around 157 nm.<sup>30,31</sup> Thermalized holes are 84 involved in the mechanism of photoinitiated etching of Si in 85 HF.<sup>32–34</sup> On the basis of electronic state energetics, Kolasinski 86 has unambiguously determined<sup>34</sup> that the hole resides in a Si– 87 Si backbond bulk state localized near the surface. The hole is 88 not located in the Si−H bond, nor is it capable of dissociating 89 the Si−H bond. This state is the active state in the exciton 90 model of Stewart and Buriak.<sup>18</sup>

We need to consider what can influence and even enhance 91 92 the reactivity of the valence band hole. Foremost, the hole must 93 not recombine effectively with a conduction band electron. 94 Band bending can lead to separation of these carriers, especially 95 when only a fraction of the surface is illuminated.<sup>33,35</sup> When the 96 nucleophile is strong, such as F<sup>-</sup>, this promotes significant 97 reactivity. Hence, localized but not full surface laser excitation 98 with above band gap radiation of Si in HF(aq) leads to 99 formation of por-Si in the area that contains the holes: the 100 irradiated area of n-type Si<sup>36</sup> or the unirradiated portion of p-101 type Si.<sup>33</sup> Faster and more reliable reactivity on both n- and p-102 type wafers is induced if the hole and electron are not only 103 separated, but if the electron is completely removed from the Si 104 substrate all together. This is accomplished in stain etching in 105 which an oxidant in solution removes an electron and injects a 106 hole into the valence band.<sup>37–39</sup>

<sup>107</sup> The solid state electronic energy  $\varepsilon$  in electronvolts in which <sup>108</sup> the vacuum level is used as the energetic origin  $\varepsilon_{vac} = 0$  is <sup>109</sup> related to the electrochemical reduction potential *E* in volts <sup>110</sup> by<sup>40</sup>

$$\varepsilon = -4.43 \text{ eV} - eE \tag{1}$$

112 The energetic origin of the electrochemical energy scale is the 113 standard hydrogen electrode (SHE) at 0 V, which has a work 114 function of 4.43 eV, and *e* is the elementary charge on the 115 electron. The band structure of por-Si depends on the 116 nanocrystallite size distribution because of quantum confine-117 ment.<sup>41</sup> For example,  $E_{\rm C} = -0.22$  V versus SHE and  $\varepsilon_{\rm gap} = 1.12$ 118 eV for 1  $\Omega$  cm p-type Si(100) in 2 M HF.<sup>42</sup> However, for a 119 particular preparation of por-Si, Rehm et al.<sup>43</sup> found  $E_{\rm C} = -1.20$ 120 V and a band gap of  $\varepsilon_{\rm gap} = 2.6$  eV.

Excitation of electron hole pairs requiring above band gap 121 122 radiation requires significantly bluer photons on por-Si ( $\lambda_{gap} \leq$ 123 480 nm, for the visibly photoluminescent sample of Rehm et 124 al.) or sufficiently small nanocrystals of Si as compared to c-Si  $(\lambda_{gap} \leq 1110 \text{ nm})$  because of band gap widening. Photo-125 emission is possible once the photon energy exceeds the work 126 127 function. However, since Si is a semiconductor, the density of states is necessarily low at the Fermi energy  $\varepsilon_{\rm F}$  and is only the 128 129 result of defect states. Unless these defects are close to the surface, it is unlikely that photoelectrons released from them 130 can actually leave the sample before collisional relaxation. 131 132 Photoelectron production occurs to a substantial extent only when photons can promote electrons from the energy of the 133 134 valence band maximum  $\varepsilon_{\rm V}$ . This requires ultraviolet light of  $\lambda_{\rm VB}$  $135 \leq 240$  nm on c-Si or  $\lambda_{VB} \leq 210$  nm on por-Si.

136 Internal photoemission removes the excited electron from 137 the Si and thereby lowers the recombination rate with the 138 valence band hole. The hole has a longer lifetime than if the 139 electron were excited to the conduction band. This intrinsically increases the effective reactivity of the hole toward nucleophilic 140 attack by a solution phase species such as terminal alkenes. 141 Hamers and co-workers achieved a high probability for internal 142 photoemission by choosing molecules with an acceptor level 143 under the Si vacuum level and by using 254 nm light. It should 144 be noted that while charge transfer is generally most rapid to 145 the lowest energy acceptor state, internal photoemission is 146 possible not just to the lowest available state (the acceptor level 147 corresponding to the reduction potential) but to any 148 energetically accessible acceptor level. 149

To increase the hole lifetime, the excited electron must be  $_{150}$  transferred to a trap state. An excited state such as  $|S3\rangle$  in  $_{151}$  Figure 1 is unstable and relaxes with a lifetime on the order of a  $_{152}$  fi



Figure 1. S1, S2, S3 and S4 represent substrate electronic states within the valence or conduction bands. A1, A2 and A3 represent molecular acceptor states in solution phase or adsorbed species.

few femtoseconds, rapidly relaxing to the conduction band 153 minimum. This is very short compared to the radiative 154 recombination time that determines the lifetime of electrons 155 at the conduction band minimum in well-passivated Si, which 156 has a lifetime on the order of a few nanoseconds to tens of 157 microseconds, depending on temperature, surface termination, 158 and nanocrystallite size. 159

To significantly increase the hole lifetime, the electron must 160 be transferred to a long-lived adsorbate state. Candidate states | 161 A1 $\rangle$  and |A3 $\rangle$  are shown in Figure 1. As mentioned above, 162 population of these states can be accomplished by internal 163 photoemission. The rate of radiative excitation  $W_{\rm fi}$  from initial 164 state  $|i\rangle$  to final state  $|f\rangle$  is given by the Fermi golden rule 165 expression 166

16

$$W_{\rm fi} = \frac{2\pi}{\hbar} |V_{\rm fi}|^2 \rho(\varepsilon_{\rm fi})$$
<sup>(2)</sup>

168 where the transition dipole matrix element is  $V_{\rm fi} = \langle f | \vec{\mu} | i \rangle$  and 169  $\rho(\varepsilon_{\rm fi})$  is the power density at the resonance energy  $\varepsilon_{\rm fi}$ . The 170 transition dipole matrix element depends on the orbital nature 171 of the initial bulk state and the final acceptor state. Therefore, 172 there is no reason for the internal photoemission probability to 173 depend in a direct way on the reduction potential.

Consider two degenerate levels, one in the conduction band | 175 S3 and one localized on a molecular acceptor |A3 ). There are 176 two ways to populate the state |A3 ). The first is direct 177 photoexcitation from a valence band state |S1 ). Whether the 178 probability of an optical transition is greater for  $|S1 \rangle \rightarrow |S3 \rangle$  or | 179 S1  $\rangle \rightarrow |A3 \rangle$  depends on the relative magnitude of the transition 180 dipole matrix elements  $|S3 \rangle |\vec{\mu}|S1 \rangle$  compared to  $|A3 \rangle |\vec{\mu}|S1 \rangle$ .

The second way to transfer the electron into  $|A3\rangle$  is optical excitation to  $|S3\rangle$  followed by an electron transfer event  $|S3\rangle \rightarrow$  $|A3\rangle$ . Here we assume that the molecules are weakly coupled (physisorbed or nonspecifically adsorbed) to the Si surface such that Marcus theory can be used to calculate the rate of electron transfer.<sup>46</sup>

The rate of electron transfer from the conduction band can188 be written

$$R_{\rm inj} = c_{\rm ox} N_{\rm C} k_{\rm max} W(E) \tag{3}$$

190 where  $N_{\rm C}$  is the density of states in the conduction band,  $k_{\rm max}$  is 191 the optimal rate constant, and W(E) is the Marcus hop 192 probability factor that depends on the relative position of the 193 acceptor level compared to the energy of the valence band edge 194  $E_{\rm C}$ . For an oxidant with Nernst potential  $E_{\rm ox}$ 

<sub>195</sub> 
$$W(E) = \exp[-((E_{\rm C} - E_{\rm ox} + \lambda_{\rm e})^2/4\lambda_{\rm e}k_{\rm B}T)]$$
 (4)

<sup>196</sup>  $\lambda_{\rm e}$  is the solvent reorganization energy (about 0.5–1.5 eV for <sup>197</sup> organic species at a semiconducting electrode), and  $k_{\rm B}$  is the <sup>198</sup> Boltzmann constant.  $k_{\rm max}$  occurs when the activation Gibbs <sup>199</sup> energy  $\Delta G^{\ddagger}$  vanishes as defined by

$$\Delta G^{\ddagger} = (E_{\rm C} - E_{\rm OX} + \lambda_{\rm e})/4\lambda_{\rm e} = 0$$
<sup>(5)</sup>

This condition defines the onset of the inverted region for 202 electron transfer. Lewis and co-workers,<sup>47–51</sup> have measured a 203 value of  $k_{\rm max} \approx 10^{-25}$  to  $10^{-24}$  m<sup>4</sup> s<sup>-1</sup> with Si, ZnO, InP, and 204 GaAs electrodes. They have shown that this value is consistent 205 with the maximum magnitude of  $k_{\rm max}$  calculated quantum 206 mechanically from

$$k_{\rm max} = \frac{2\pi}{\hbar} \left| H_{\rm DA} \right|^2 \beta^{-1} (4\pi \lambda_{\rm e} k_{\rm B} T)^{1/2} \frac{l_{\rm Si}}{\rho_{\rm A}^{2/3} (6/\pi)^{1/3}} \tag{6}$$

208 where  $l_{\rm Si}$  is the effective coupling length in the semiconductor, 209  $\beta \approx 1$  Å is the tunneling range parameter, and  $H_{\rm DA}$  is the 210 coupling matrix element for the electron transfer Hamiltonian 211  $H_{\rm et}$  between the donor and acceptor levels  $|D\rangle$  and  $|A\rangle$ . The 212 coupling matrix element  $H_{\rm DA}$  depends on orbital overlap and 213 symmetry. Thus, it varies exponentially with distance *r* from the 214 distance of closest approach  $r_{\rm m}$  according to

$$_{215} \quad |H_{\rm DA}|^2 = |\langle D|H_{\rm et}|A\rangle|^2 = V_0 \exp[\beta(r - r_{\rm m})/2]$$
(7)

What should be apparent from Figure 1 and eqs 3–7 is that 217 as long as  $|A3\rangle$  lies above  $E_{C}$  there always exists a state  $|S2\rangle$  that 218 lies at lower energy than  $|S3\rangle$ . Therefore, the activation Gibbs 219 energy for electron transfer  $|A3\rangle \rightarrow |S2\rangle$  must be less than for | 220  $S3\rangle \rightarrow |A3\rangle$ , and the rate of electron transfer out of  $|A3\rangle$  must be greater than rate of electron transfer into  $|A3\rangle$ . In other 221 words,  $|A3\rangle$  can never act as an electron trap state in the two- 222 step mechanism as long as it resides above the conduction band 223 minimum. A higher energy state such as  $|S4\rangle$  could only 224 efficiently transfer electrons to  $|A3\rangle$  if the electron transfer rate 225 were competitive with nonradiative relaxation in the con- 226 duction band, which is unlikely.  $|A3\rangle$  can only act as a trap state 227 if electron transfer to the conduction band is slow compared to 228 the direct optical excitation rate and the rate of diffusion of the 229 molecule away from the surface. 230

On the other hand, a state such as  $|A1\rangle$ , which resides in the 231 band gap, can act as an effective trap state. Electron transfer 232 from  $|A1\rangle$  into the conduction band is slow because of the need 233 for thermal activation to go back up to the conduction band at 234 higher energy. The rate of electron transfer to the valence band 235 is low because of the low density of empty states in the valence 236 band. 237

On the basis of these considerations, I constructed a model 238 based on photochemistry induced by two competing processes: 239 (1) direct photoexcitation by internal photoemission and (2) 240 charge transfer via the conduction band by electrons that have 241 relaxed to the conduction band minimum. The rate of 242 photochemistry is determined by the concentration of holes 243 at the surface. Holes are produced by photoexcitation and lost 244 by recombination. Assuming that the only holes to react are 245 those that are made free of recombination by removal of the 246 excited electron by direct internal photoemission or charge 247 transfer, the yield is represented by the sum of these two 248 contributions 249

$$Y(\lambda_{\text{ex}}, E_{\text{red}}, \lambda_{\text{e}}, E_{\text{C}}) = R_{\text{direct,ox}}(\lambda_{\text{ex}}) + R_{\text{inj}}(E_{\text{red}}, \lambda_{\text{e}}, E_{\text{C}})$$
(8) 250

The rate of direct excitation of the particular oxidant ox 251 depends on the excitation wavelength  $\lambda_{ex}$ . To minimize the 252 number of parameters in the model, this rate is taken to be a 253 constant R<sub>direct</sub>. Although this may seem a severe approx- 254 imation, note that a sufficiently small  $\lambda_{\mathrm{ex}}$  will always be able to 255 make a resonant transition from an appropriate initial state in 256 the valence band and that Huck and Buriak utilized a white 257 light source for irradiation. Monochromatic irradiation of the 258 surface would be more likely to produce values of  $R_{direct}$  that 259 vary from one species to the next as expected according to the 260 resonance and density of states dependences in eq 2. Because 261 the lifetime of electrons excited high in the conduction band is 262 so short,  $R_{inj} = 0$  for any state above the conduction band 263 minimum  $(\vec{E}_{red} < E_c)$ . Therefore, the yield of species *i* relative 264 to dodecene is 265

$$Y_{\rm rel} = \frac{Y_i}{Y_{\rm d}} = \frac{R_{\rm direct} + R_{\rm inj,i}}{R_{\rm direct}} = 1 + R_{\rm inj,i}/R_{\rm direct}$$
(9) 266

Substituting from eq 6 and further limiting the number of 267 parameters by assuming  $k_{\text{max}} = 5 \times 10^{-25} \text{ m}^4 \text{ s}^{-1}$  and  $\lambda_e$  is the 268 same for the solvated oxidants, a two-parameter model is 269 obtained to fit the relative yield data of Huck and Buriak 270 (Figure 2).<sup>20</sup> The result is an excellent fit with  $R_{\text{direct}} = (5.2 \pm 271 \text{ fz} 1.2) \times 10^{26} \text{ m}^{-2} \text{ s}^{-1}$  and  $\lambda_e = 1.1 \pm 0.06 \text{ eV}$ . The fit was 272 weighted by the reported experimental uncertainty and 273 uncertainties of fit parameters are reported at 95% confidence 274 limits.

Recall that the band gap and  $E_{\rm C}$  depend on the nano- 276 crystallite size. This engenders the self-limiting nature of Si 277 etching in acidic fluoride solutions that leads to nanostructure 278



**Figure 2.** The result of a weighted fit of eq 9 to the data of Huck and Buriak.<sup>20</sup> The conduction band minimum and valence band maximum positions indicated are for the case of por-Si referenced in the text. After attaining the optimal rate constant, the yield is predicted to plunge in the inverted region.

279 formation.<sup>41</sup> Therefore, it is possible not only to tune the rate 280 of photoinduced electron transfer from the conduction band to 281  $|A1\rangle$ , but also to tune this according to the size of the 282 nanocrystalline Si object (pore wall or nanocrystal) that is in 283 contact with the molecular acceptor level. The rate of electron 284 transfer is tuned by choosing  $E_{ox}$  and  $\lambda_e$  appropriately because 285 the optimal electron transfer rate occurs at

$$E_{\rm C} - E_{\rm ox} + \lambda_{\rm e} = 0 \tag{10}$$

As noted above, the band gap of c-Si corresponds to the 288 energy of a photon with wavelength  $\lambda_{gap} = 1110$  nm, but for 289 por-Si,  $\lambda_{gap} = 480$  nm. Therefore, by choosing blue or UV light, 290 we can excite electrons across the band gap of all nano-291 crystallites in a sample. Alternatively, by choosing a redder 292 wavelength, we can preferentially excite only the larger 293 nanocrystals.

A molecule with  $E_{ox} = -0.2$  V and  $\lambda_e = 1.0$  eV would accept 294 295 electrons from the por-Si at the optimal rate. However, since it 296 is resonant with the conduction band, it would be a poor trap 297 state for c-Si. This molecule would very effectively enhance the photo reactivity of small nanocrystals but do much less to 298 enhance the reactivity of large crystallites and flat Si surfaces. 2.99 A molecule with  $E_{ox} = +0.78$  V and  $\lambda_e = 1.0$  eV would accept 300 301 electrons from the c-Si at the optimal rate but would lie in the 302 inverted region for por-Si, thus acceping electrons at a much 303 lower rate. Consequently, we can bias reactivity toward flat 304 surfaces or larger crystallites or to smaller crystallites by choice 305 of excitation wavelength and by choice of the acceptor 306 molecule.

#### 307 CONCLUSIONS

308 Internal photoemission can be quite effective at promoting 309 photoreactivity, especially not only when the acceptor level 310 resides in a band gap, but also when the level is strongly 311 optically coupled to the valence band. Diamond is an 312 exceptionally well-suited material because of its extremely 313 wide band gap and a vacuum level positioned below the conduction band minimum. Indeed, Hamers and co-workers <sup>314</sup> have exploited this for efficient covalent modification of <sup>315</sup> diamond and other carbonaceous surfaces.<sup>27,28</sup> A two-step <sup>316</sup> photoexcitation/charge transfer mechanism is most efficient <sup>317</sup> when the acceptor level resides in a band gap, which <sup>318</sup> quantitatively explains the results of Huck and Buriak.<sup>20</sup> <sup>319</sup> Monochromatic excitation may lead to more complex behavior <sup>320</sup> of the direct photoexcitation rate than implied in eq 9. <sup>321</sup> Nonetheless, with judicious choice of the excitation wavelength, <sup>322</sup> redox potential of the acceptor level and the reorganization <sup>323</sup> energy of the acceptor molecule, it is possible to construct <sup>324</sup> photochemical surface modification schemes that will size <sup>325</sup> selectively react with nanocrystalline Si.

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The authors declare no competing financial interest. 331

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